



Product Change Notification

Change Notification #: 116772 - 00
Change Title: For Select Intel® SSD D3-S4510 Series and Intel® SSD D3-S4610 Series SKUs, PCN 116772-00, Product Design, Firmware Update
Date of Publication: February 20, 2019

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	February 27, 2019
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Description of Change to the Customer:

The Intel® SSD D3-S4510 Series and Intel® SSD D3-S4610 Series SKUs listed in the Products Affected table below will have the firmware version updated from XCV10100 to XCV10110. Inventory will transition in the Intel factory on the above date to replace older firmware version with the latest version.

Customer Impact of Change and Recommended Action:

Intel will be shipping only post-conversion material starting the date identified above. Customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Product Name	Product Code	MM#	Pre Change TA	Pre Change SA	Post Change TA	Post Change SA
Intel® SSD D3-S4510 Series (1.92TB, 2.5in SATA 6Gb/s, 3D2, TLC) Generic Single Pack	SSDSC2KB019T801	963343	J80284-000	J80317-000	J80284-001	J80317-001
Intel® SSD D3-S4510 Series (3.84TB, 2.5in SATA 6Gb/s, 3D2, TLC) Generic Single Pack	SSDSC2KB038T801	963344	J80285-000	J80319-000	J80285-001	J80319-001
Intel® SSD D3-S4610 Series (1.92TB, 2.5in SATA 6Gb/s, 3D2, TLC) Generic Single Pack	SSDSC2KG019T801	963348	J80302-000	J80309-000	J80302-001	J80309-001
Intel® SSD D3-S4510 Series (1.92TB, 2.5in SATA 6Gb/s, 3D2, TLC) Generic 50 Pack	SSDSC2KB019T8	963352	J80289-000	J80317-000	J80289-001	J80317-001
Intel® SSD D3-S4510 Series (3.84TB, 2.5in SATA 6Gb/s, 3D2, TLC) Generic 50 Pack	SSDSC2KB038T8	963353	J80290-000	J80319-000	J80290-001	J80319-001
Intel® SSD D3-S4610 Series (1.92TB, 2.5in SATA 6Gb/s, 3D2, TLC) Generic 50 Pack	SSDSC2KG019T8	963358	J80306-000	J80309-000	J80306-001	J80309-001
Intel® SSD D3-S4610 Series (3.84TB, 2.5in SATA 6Gb/s, 3D2, TLC) Generic Single Pack	SSDSC2KG038T801	963969	J82594-000	J82597-000	J82594-001	J82597-001
Intel® SSD D3-S4610 Series (3.84TB, 2.5in SATA 6Gb/s, 3D2, TLC) Generic 50 Pack	SSDSC2KG038T8	963970	J82595-000	J82596-000	J82595-001	J82596-001

PCN Revision History:

Date of Revision:
February 20, 2019

Revision Number:
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Reason:
Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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